

---

## Features

- 64K x 32-bit Flash Embedded Memory Cell
- Fast Read Access Time
  - Random Access Time: 70 ns Worst Case (Process, Voltage, Temperature)
  - Page Access Time: 40 ns Worst Case (Process, Voltage, Temperature)
- Single Supply Voltage: 1.8V  $\pm$ 10%
- Page Program Operation
  - 1024 Pages (64 Words/Page)
  - Internal Data Latches For 64 Words
  - Read Capability During Data Load
- Program Cycle Time: 4 ms per Page Including Auto-erase
- Full Chip Erase Available in 10 ms
- rdybsyn Signal For End of Program Detection
- Very Low Power Dissipation
  - 8 mA Active Current in Write and Erase
  - 4 mA Active Current in Random Read
  - 30  $\mu$ A Stand-by Current
- High Reliability CMOS Technology
  - Typical Endurance: 100K Write/Word
  - Data Retention: 10 Years
- Erased State (Charged Gate) Is a Logic “1”

## Description

The 64K x 32-bit cell is an embedded 2-Mbit Flash electrically erasable and programmable read only memory with a power supply of 1.8V  $\pm$ 10%. The memory is organized as 1024 pages of 64 32-bit words each. The device uses the Atmel ATC18 0.18  $\mu$ m silicon process. For easy reprogrammability, it does not require a high input voltage for programming: the embedded Flash can be operated with a single 1.8V  $\pm$ 10% power supply.

Re-programming the cell is performed on a page basis: the words to be written (from a minimum of 1 word to a maximum of 64 words) are loaded into the device and then simultaneously written into the targeted page after the full page has been erased during the auto-erase phase. 2 ms are necessary to erase the page, followed by 2 ms to write the words, independent of the number of words that are written in parallel into the targeted page. Thus the write time after the auto-erase varies from a maximum of 2 ms per word if only 1 word is written to a minimum of 32  $\mu$ s per word if the entire page is written at a time. Memory read is allowed during data loading and forbidden once programming has started. The signal rdybsyn pulses low at the beginning of the program cycle to indicate that the memory is not ready for a read operation. Programming the entire memory can be done using a full chip erase followed by 1024 page write without auto-erase. Compared to full-memory programming using auto-erase on each page, the programming time is reduced by half. At the end of each program cycle, the rdybsyn signal pulses high to indicate that programming is completed and the memory available for a new program or read cycle. Reading data out of the device can be done in an asynchronous and random manner, with 70 ns access time.



---

## Embedded ASIC Memory Cell

---

## ATC18 64K x 32-bit Low-power Flash

## Advance Information

Rev. 2680A-CASIC-11/02





## DC and AC Operating Range

Conditions are:

- Operating temperature: -40°C to 85°C

**Table 1.** Parameters

Symbol	Parameter	Min	Typ	Max	Units
$V_{DD}$	Power Supply	1.6	1.8	2.0	
$t_{ACC}$	Read Access Time			70	ns
$t_{BACC}$	Page Access Time			40	
$t_{WC}$	Write Cycle Time <sup>(1)</sup>			4	ms

Note: 1. The max value includes auto-erase.

**Table 2.** DC Characteristics

Symbol	Parameter	Condition	Max
$I_{SB}$	Standby Current	$V_{DD} = 2.0V$	30 $\mu A$
$I_{CC}$	Active Current	Random Read: $V_{DD} = 2.0V, 10\text{ MHz}$	4.0 mA
		Write: $V_{DD} = 2.0V$	8.0 mA







## Atmel Headquarters

### *Corporate Headquarters*

2325 Orchard Parkway  
San Jose, CA 95131  
TEL 1(408) 441-0311  
FAX 1(408) 487-2600

### *Europe*

Atmel Sarl  
Route des Arsenaux 41  
Case Postale 80  
CH-1705 Fribourg  
Switzerland  
TEL (41) 26-426-5555  
FAX (41) 26-426-5500

### *Asia*

Room 1219  
Chinachem Golden Plaza  
77 Mody Road Tsimhatsui  
East Kowloon  
Hong Kong  
TEL (852) 2721-9778  
FAX (852) 2722-1369

### *Japan*

9F, Tonetsu Shinkawa Bldg.  
1-24-8 Shinkawa  
Chuo-ku, Tokyo 104-0033  
Japan  
TEL (81) 3-3523-3551  
FAX (81) 3-3523-7581

## Atmel Operations

### *Memory*

2325 Orchard Parkway  
San Jose, CA 95131  
TEL 1(408) 441-0311  
FAX 1(408) 436-4314

### *Microcontrollers*

2325 Orchard Parkway  
San Jose, CA 95131  
TEL 1(408) 441-0311  
FAX 1(408) 436-4314

La Chantrerie  
BP 70602  
44306 Nantes Cedex 3, France  
TEL (33) 2-40-18-18-18  
FAX (33) 2-40-18-19-60

### *ASIC/ASSP/Smart Cards*

Zone Industrielle  
13106 Rousset Cedex, France  
TEL (33) 4-42-53-60-00  
FAX (33) 4-42-53-60-01

1150 East Cheyenne Mtn. Blvd.  
Colorado Springs, CO 80906  
TEL 1(719) 576-3300  
FAX 1(719) 540-1759

Scottish Enterprise Technology Park  
Maxwell Building  
East Kilbride G75 0QR, Scotland  
TEL (44) 1355-803-000  
FAX (44) 1355-242-743

### *RF/Automotive*

Theresienstrasse 2  
Postfach 3535  
74025 Heilbronn, Germany  
TEL (49) 71-31-67-0  
FAX (49) 71-31-67-2340

1150 East Cheyenne Mtn. Blvd.  
Colorado Springs, CO 80906  
TEL 1(719) 576-3300  
FAX 1(719) 540-1759

### *Biometrics/Imaging/Hi-Rel MPU/ High Speed Converters/RF Datacom*

Avenue de Rochepleine  
BP 123  
38521 Saint-Egreve Cedex, France  
TEL (33) 4-76-58-30-00  
FAX (33) 4-76-58-34-80

---

### *e-mail*

[literature@atmel.com](mailto:literature@atmel.com)

### *Web Site*

<http://www.atmel.com>

### © Atmel Corporation 2002.

Atmel Corporation makes no warranty for the use of its products, other than those expressly contained in the Company's standard warranty which is detailed in Atmel's Terms and Conditions located on the Company's web site. The Company assumes no responsibility for any errors which may appear in this document, reserves the right to change devices or specifications detailed herein at any time without notice, and does not make any commitment to update the information contained herein. No licenses to patents or other intellectual property of Atmel are granted by the Company in connection with the sale of Atmel products, expressly or by implication. Atmel's products are not authorized for use as critical components in life support devices or systems.

ATMEL® is the registered trademark of Atmel.

Other terms and product names may be the trademarks of others.



Printed on recycled paper.

2680A-CASIC-11/02 0M